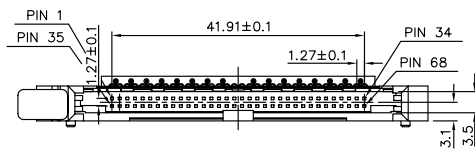
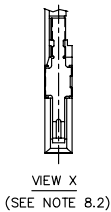
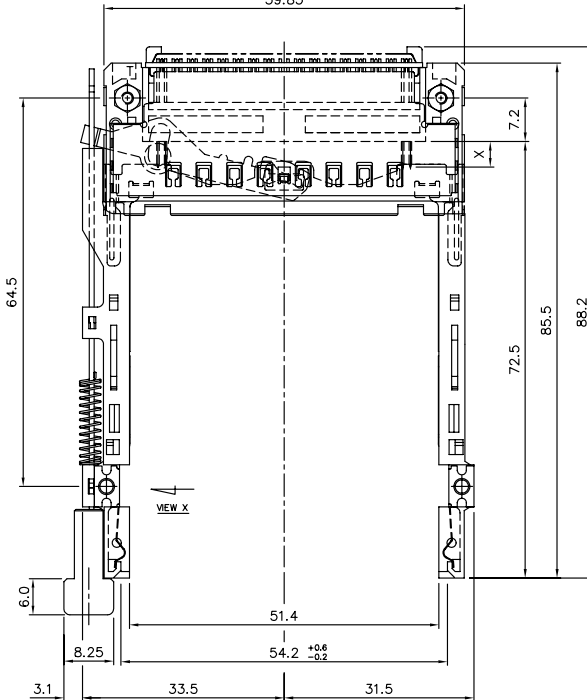
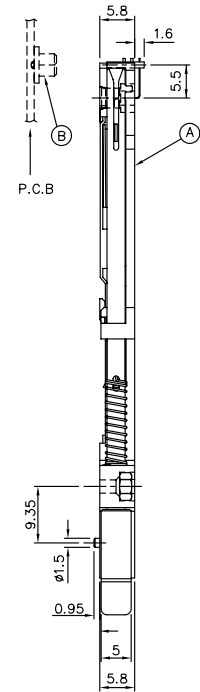
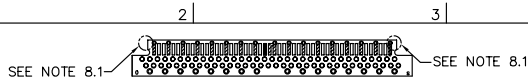


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PRODUCT NO.  
52366-100DAS/100DASLF



NOTES:

- 8.0mm MIN CARD EJECT.
  - EJECT TRAVEL: 9.50mm
  - MATERIAL:  
EJECT HEADER ASS'Y  
PLASTIC HOUSING: LCP UL94V-0 BLACK  
PIN: COPPER ALLOY  
PCB: FR4  
PLASTIC GUIDE: POLYPHTHARAMID UL94V-0 COLOR : BLACK.  
PLATE: STAINLESS  
EMI CONTACT: PHOSPHOR BRONZE
  - FINISH  
PIN :  
UNDER PLATING: 0.5um MIN. Ni  
CONTACT AREA: 0.1um MIN. GOLD OVER  
                  0.5um MIN. Pd-Ni  
SOLDER TAIL(TIN LEAD OPTION): 2.5um MIN. Sn-Pb  
SOLDER TAIL(LEAD FREE OPTION): 2.5um MIN. PURE TIN  
GROUND SHIELD :  
UNDER PLATING: 0.75um MIN. Ni  
CONTACT SURFACE: 0.2 um GOLD.
  - PUSH ROD LOCATION AND P.C.B. ARE AS APPEARS INSTALLED
  - DIM "X"
- |          |         |                  |
|----------|---------|------------------|
| 4.25±0.1 | 3.5±0.1 | 5.0±0.1          |
| OTHERS   | 36,67   | 1,17,34,35,51,68 |
- DO NOT TOUCH AND KEEP CLEAN THE SURFACES OF PCB OF HEADER ASS'Y.
  - SPECIAL FEATURES:  
8.1 NO CHAMFER OF VTB  
8.2 NO "S"-SLOT
  - IF LEAD FREE P.N.THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C PEAK TEMPERATURE FOR 10 SECONDS IN A WAVE SOLDER APPLICATION WITH A 1.00MM MINIMUM THICK CIRCUIT BOARD.
  - IF LEAD FREE P/N.THE PRODUCT MEETS EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATIONS AS DISCRIBLED IN GS-22-008
  - LEAD FREE P/N PACKAGING MEETS GS-14-920 SPECIFICATION

ORDERING INFORMATION

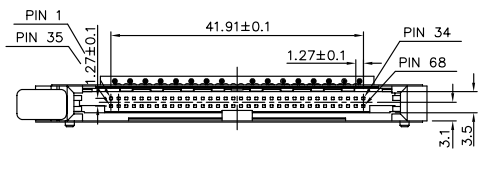
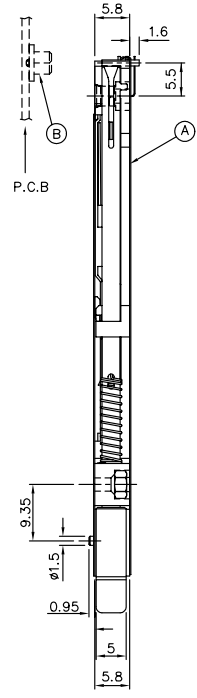
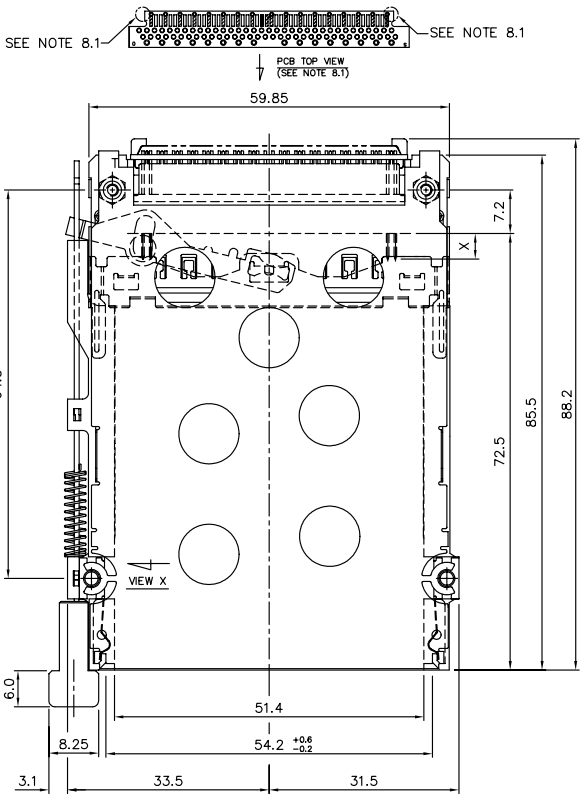
NAME	PART NO.	Q'TY
(A) EJECT HEADER ASS'Y	52366-100DAS/100DASLF	1
(B) MATING RECEPTACLE	73277-101002/101002LF	1

mat'l code		tolerance unless otherwise specified		CUSTOMER COPY		FCJ www.fciconnect.com	
rev.	ecn no.	dr	date	linear	± 0.30	projection	title
A	T90248	WL	07/06/99				CARDBUS EJECT HEADER
B	T90287	WL	06/03/99				FORCE-SAVING, TYPE 1/2/3
C	T90359	WL	10/14/99	angles	± 2°		
D	T00105	WL	04/11/00	dr	WENDY CHEN	06/25/99	unit
E	T10151	WL	05/28/01	engr	STELAR CHU	06/25/99	mm/inch
F	N05-0037	WB	02/16/05	chr	JOSEPH HSIAO	06/25/99	scale
				appd	JENN TSAO	06/25/99	1.5:1
sheet	revision	F	F	F			product family : PCMCIA
index	sheet	1	2	3			code
							size
							dwg no.
							A3
							52366
							1 of 3

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PRODUCT NO.  
52366-300DAS/300DASLF



- NOTES:  
 1 8.0mm MIN CARD EJECT.  
 2 EJECT TRAVEL: 9.50mm  
 3 MATERIAL:  
 EJECT HEADER ASS'Y  
 PLASTIC HOUSING: LCP UL94V-0 BLACK  
 PIN: COPPER ALLOY  
 PCB: FR4  
 PLASTIC GUIDE: POLYPHTHARAMID UL94V-0 COLOR : BLACK.  
 PLATE: STAINLESS  
 EMI CONTACT: PHOSPHOR BRONZE  
 4 FINISH  
 PIN  
 UNDER PLATING: 0.5um MIN. Ni  
 CONTACT AREA: 0.1um MIN. GOLD OVER  
 0.5um MIN. Pd-Ni  
 SOLDER TAIL(TIN LEAD OPTION): 2.5um MIN. Sn-Pb  
 SOLDER TAIL(LEAD FREE OPTION): 2.5um MIN. PURE TIN  
 GROUND SHIELD :  
 UNDER PLATING: 0.75um MIN. Ni  
 CONTACT SURFACE: 0.2 um GOLD.  
 5 PUSH ROD LOCATION AND P.C.B. ARE AS  
 APPEARS INSTALLED  
 6 DIM "X"  

4.25±0.1	3.5±0.1	5.0±0.1
OTHERS	36,67	1,17,34,35,51,68

 7 DO NOT TOUCH AND KEEP CLEAN THE SURFACES  
 OF PCB OF HEADER ASS'Y.  
 8 SPECIAL FEATURES:  
 8.1 NO CHAMFER OF VTB  
 8.2 NO "S"-SLOT  
 9 IF LEAD FREE P.N.THE HOUSING WILL WITHSTAND EXPOSURE TO  
 260°C PEAK TEMPERATURE FOR 10 SECONDS IN A WAVE SOLDER  
 APPLICATION WITH A 1.00MM MINIMUM THICK CIRCUIT BOARD.  
 10 IF LEAD FREE P/N.THE PRODUCT MEETS EUROPEAN UNION DIRECTIVES  
 AND OTHER COUNTRY REGULATIONS AS DISCRIBLED IN GS-22-008  
 11 LEAD FREE P/N PACKAGING MEETS GS-14-920 SPECIFICATION

ORDERING INFORMATION

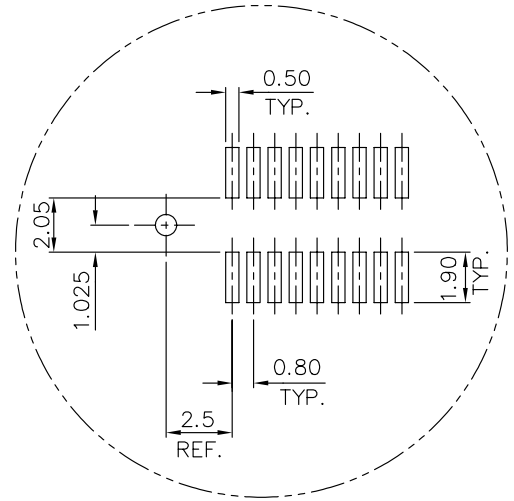
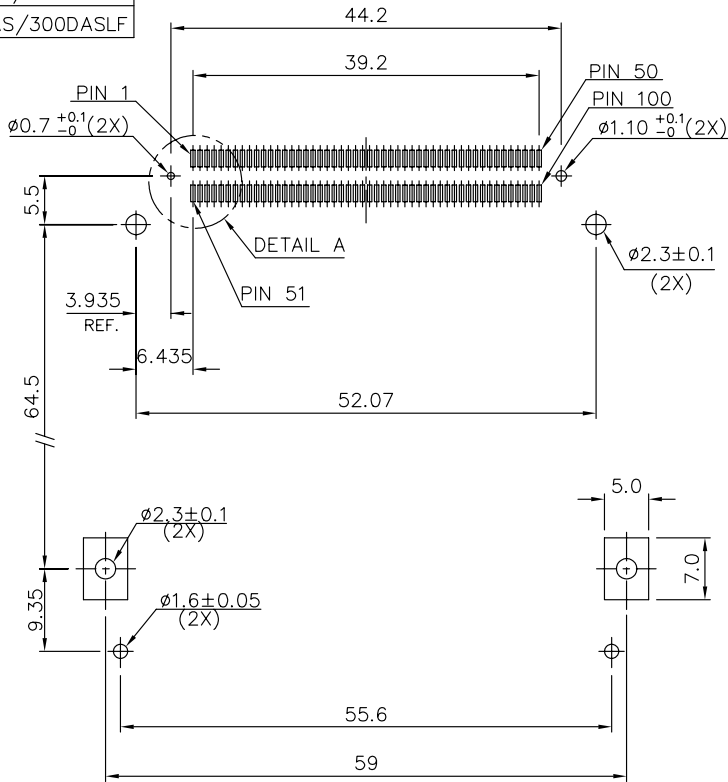
NAME	PART NO.	Q'TY
(A) EJECT HEADER ASS'Y	52366-300DAS/300DASLF	1
(B) MATING RECEPTACLE	73277-101002/101002LF	1

mat'l code	tolerance unless otherwise specified	CUSTOMER COPY	 www.fcjconnect.com
rev. ecn no. dr date	linear ± 0.30	projection	
F	angles ± 2°		title CARDBUS EJECT HEADER FORCE-SAVING, TYPE 1/2/3 product family : PCMCIA size dwg no. 52366 code TWN sheet 2 of
sheet revision	dr WENDY CHEN 06/25/99	unit	
index sheet	enrg STELAR CHU 06/25/99	mm/inch	
	chr JOSEPH HSIAO 06/25/99	scale	
	appd JENN TSAO 06/25/99	1.5:1	
	sheet		
	revision		
	index		
	sheet		

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
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PRODUCT NO.
52366-100DAS/100DASLF
52366-300DAS/300DASLF



DETAIL A

4 CARD INSERTION DIRECTION

mat'l code		tolerance unless otherwise specified		CUSTOMER COPY		 www.fcjconnect.com	
rev.	ecn no.	dr	date	linear	± 0.10	projection	title
F				angles	± 2°		CARDBUS EJECT HEADER SMT, TYPE 1/2/3
				dr	WENDY CHEN/06/25/99	unit	product family : PCMCIA
				enrg	STELAR CHU/06/25/99	mm/inch	code
				chr	JOSEPH HSIAO/06/25/99	scale	TWN
				appd	JENN TSAO/06/25/99	2:1	sheet
sheet	revision						52366
index	sheet						3 of

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